

30 V, complementary N/P-channel Trench MOSFET27 June 2016Product

Product data sheet

1. General description

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1010B-6 (SOT1216) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Trench MOSFET technology
- Very low threshold voltage for portable applications: $V_{GS(th)} = 0.7 V$
- Leadless ultra small and ultra thin SMD plastic package: 1.1 × 1.0 × 0.37 mm
- ElectroStatic Discharge (ESD) protection > 2 kV HBM

3. Applications

- Relay driver
- High-speed line driver
- Level shifter
- · Power management in battery-driven portables

4. Quick reference data

Table 1. Quic	ck reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-char	nnel), Static characteristic	S					
R _{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I _D = 590 mA; T _j = 25 °C		-	550	670	mΩ
TR2 (P-chan	nnel), Static characteristic	S					
R _{DSon}	drain-source on-state resistance	V_{GS} = -4.5 V; I _D = -410 mA; T _j = 25 °C		-	1.2	1.4	Ω
TR1 (N-char	nnel)						
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	30	V
I _D	drain current	V _{GS} = 4.5 V; T _{amb} = 25 °C	[1]	-	-	590	mA
TR2 (P-chan	inel)						
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-30	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-	-410	mA

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

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5. Pinning information

Table 2.	Pinning in	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source TR1		D1 D2
2	G1	gate TR1		
3	D2	drain TR2	2 5	
4	S2	source TR2		
5	G2	gate TR2		
6	D1	drain TR1	Transparent top view	S1 S2 017aaa262
7	D1	drain TR1	DFN1010B-6 (SOT1216)	
8	D2	drain TR2		

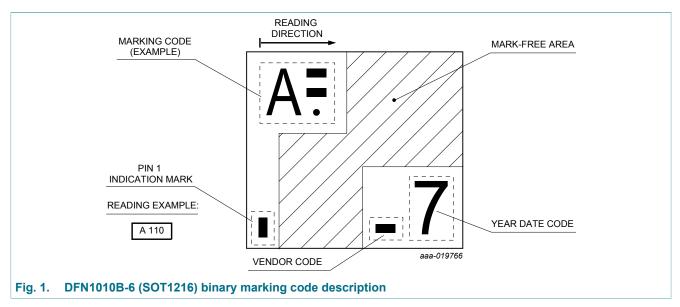
6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMCXB1000UE	DFN1010B-6	DFN1010B-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1216			

7. Marking

Table 4. Marking codes

Type number	Marking code
PMCXB1000UE	B 101



30 V, complementary N/P-channel Trench MOSFET

8. Limiting values

Table 5. Limiting values

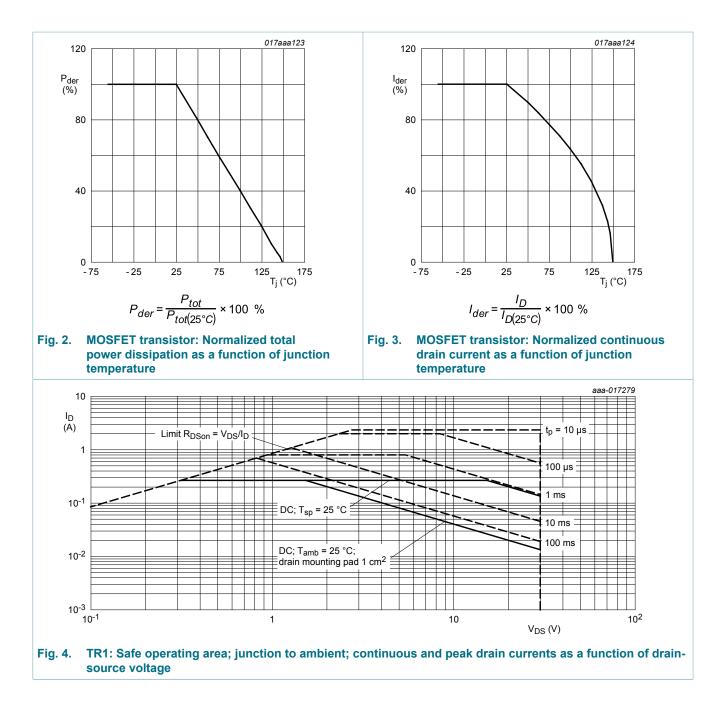
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
TR1 (N-cha	nnel)					
V _{DS}	drain-source voltage	T _j = 25 °C		-	30	V
V _{GS}	gate-source voltage			-8	8	V
I _D	drain current V_{GS} = 4.5 V; T_{amb} = 25 °C		[1]	-	590	mA
		V _{GS} = 4.5 V; T _{amb} = 100 °C	[1]	-	370	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	2.3	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	285	mW
			[1]	-	410	mW
		T _{sp} = 25 °C		-	4	W
TR2 (P-cha	nnel)		1			
V _{DS}	drain-source voltage	T _j = 25 °C		-	-30	V
V _{GS}	gate-source voltage			-8	8	V
I _D drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-410	mA	
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-260	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-1.7	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	285	mW
			[1]	-	410	mW
		T _{sp} = 25 °C		-	4	W
Per device						
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
TR1 (N-cha	nnel), Source-drain diode		1			
I _S	source current	T _{amb} = 25 °C	[1]	-	380	mA
TR2 (P-chai	nnel), Source-drain diode		1	I		
I _S	source current	T _{amb} = 25 °C	[1]	_	-410	mA

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

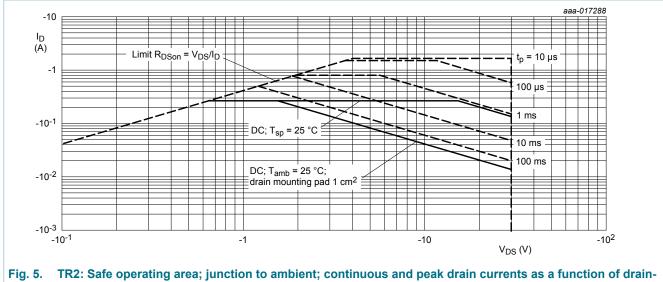
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

30 V, complementary N/P-channel Trench MOSFET



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source voltage

9. Thermal characteristics

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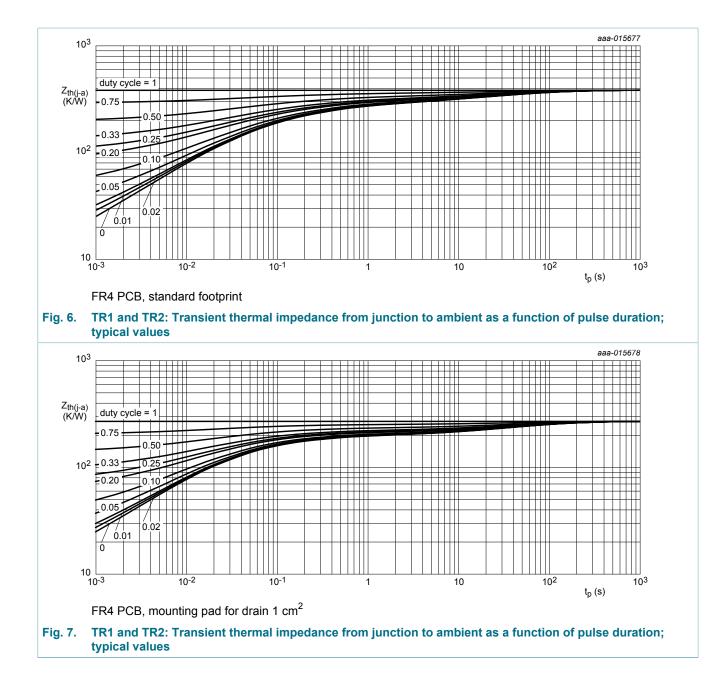
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-cha	nnel)		,				
R _{th(j-a)}	thermal resistance	in free air	[1]	-	380	440	K/W
	from junction to ambient		[2]	-	275	305	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	27	31	K/W
TR2 (P-chai	nnel)						
R _{th(j-a)}	thermal resistance	in free air	[1]	-	380	440	K/W
from junction to ambient			[2]	-	275	305	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	27	31	K/W

[1] Device mounted on an FR4 PCB, single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

PMCXB1000UE

30 V, complementary N/P-channel Trench MOSFET



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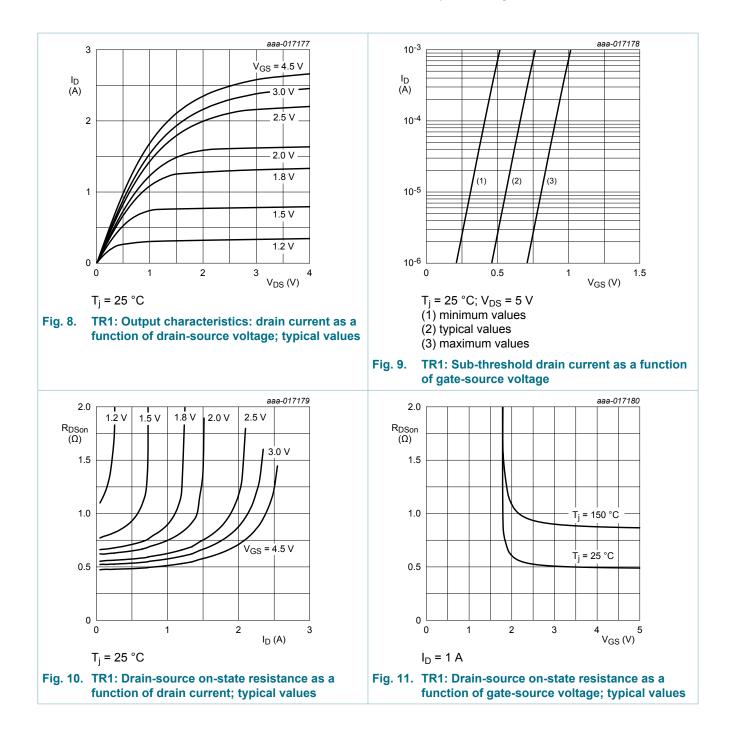
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-chai	nnel), Static characteristic	S				
V _{(BR)DSS}	drain-source breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	30	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = 250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	0.45	0.7	0.95	V
I _{DSS}	drain leakage current	V_{DS} = 30 V; V_{GS} = 0 V; T_j = 25 °C	-	-	1	μA
I _{GSS}	gate leakage current	V_{GS} = 8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	5	μA
		V_{GS} = -8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-5	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	1	μA
		V_{GS} = -4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V_{GS} = 2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V_{GS} = -2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-100	nA
Doon	drain-source on-state	V_{GS} = 4.5 V; I _D = 590 mA; T _j = 25 °C	-	550	670	mΩ
	resistance	V_{GS} = 4.5 V; I _D = 590 mA; T _j = 150 °C	-	960	1170	mΩ
		V_{GS} = 2.5 V; I_{D} = 590 mA; T_{j} = 25 °C	-	660	900	mΩ
		V_{GS} = 1.8 V; I _D = 80 mA; T _j = 25 °C	-	770	1120	mΩ
		V_{GS} = 1.5 V; I _D = 10 mA; T _j = 25 °C	-	890	1500	mΩ
9fs	forward transconductance	V_{DS} = 10 V; I _D = 590 mA; T _j = 25 °C	-	600	-	mS
TR2 (P-char	nnel), Static characteristic	s				
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -250 µA; V_{GS} = 0 V; T_j = 25 °C	-30	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-0.45	-0.7	-0.95	V
DSS	drain leakage current	V_{DS} = -30 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
GSS	gate leakage current	V_{GS} = 8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	5	μA
		V_{GS} = -8 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-5	μA
		V_{GS} = 4.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	1	μA
		V _{GS} = -4.5 V; T _j = 25 °C	-	-	-1	μA
		V_{GS} = 2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V_{GS} = -2.5 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-100	nA
R _{DSon}	drain-source on-state	V_{GS} = -4.5 V; I _D = -410 mA; T _j = 25 °C	-	1.2	1.4	Ω
	resistance	V_{GS} = -4.5 V; I _D = -410 mA; T _j = 150 °C	-	2	2.4	Ω
		V_{GS} = -2.5 V; I _D = -320 mA; T _j = 25 °C	-	1.7	2.3	Ω
		V_{GS} = -1.8 V; I _D = -80 mA; T _j = 25 °C	-	2.1	3.1	Ω
		V _{GS} = -1.5 V; I _D = -10 mA; T _i = 25 °C	-	3	5.1	Ω

30 V, complementary N/P-channel Trench MOSFET

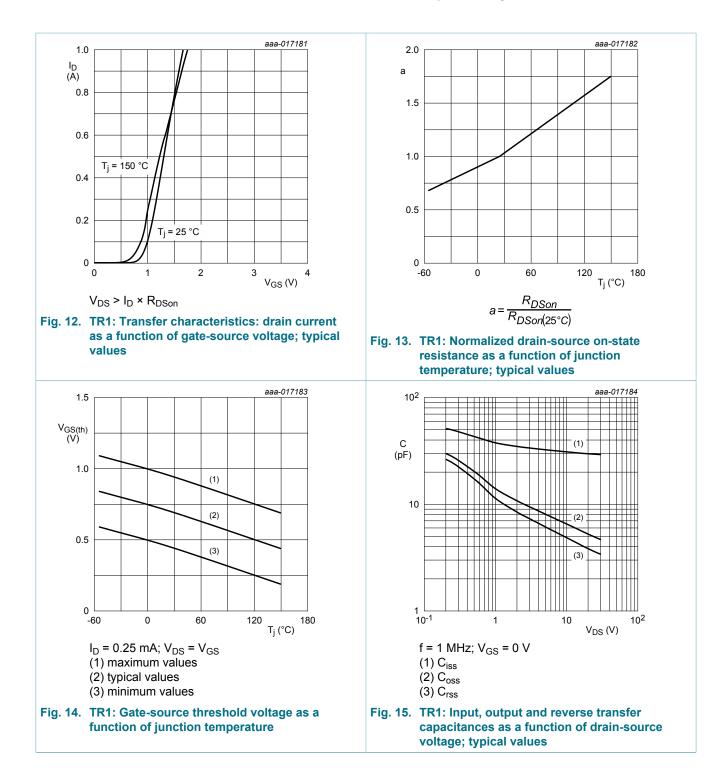
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
9 _{fs}	forward transconductance	V _{DS} = -10 V; I _D = -410 mA; T _j = 25 °C	-	820	-	mS
TR1 (N-cha	nnel), Dynamic character	istics				
Q _{G(tot)}	total gate charge	V_{DS} = 15 V; I _D = 590 mA; V _{GS} = 4.5 V;	-	0.6	1.05	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.1	-	nC
Q _{GD}	gate-drain charge		-	0.1	-	nC
C _{iss}	input capacitance	V _{DS} = 15 V; f = 1 MHz; V _{GS} = 0 V;	-	30.3	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	5.8	-	pF
C _{rss}	reverse transfer capacitance		-	4.2	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 15 V; I _D = 590 mA; V _{GS} = 4.5 V; R _{G(ext)} = 6 Ω; T _j = 25 °C	-	4	-	ns
t _r	rise time		-	7	-	ns
t _{d(off)}	turn-off delay time		-	12	-	ns
t _f	fall time		-	3	-	ns
TR2 (P-chai	nnel), Dynamic character	istics				
Q _{G(tot)}	total gate charge	V _{DS} = -15 V; I _D = -410 mA; V _{GS} = -4.5 V; T _j = 25 °C	-	0.7	1.2	nC
Q _{GS}	gate-source charge		-	0.17	-	nC
Q _{GD}	gate-drain charge		-	0.16	-	nC
C _{iss}	input capacitance	V_{DS} = -15 V; f = 1 MHz; V_{GS} = 0 V;	-	43.2	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	5.9	-	pF
C _{rss}	reverse transfer capacitance		-	4.2	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = -15 V; I _D = -410 mA;	-	3	-	ns
t _r	rise time	V_{GS} = -4.5 V; $R_{G(ext)}$ = 6 Ω ; T_j = 25 °C	-	4	-	ns
t _{d(off)}	turn-off delay time		-	14	-	ns
t _f	fall time		-	5	-	ns
TR1 (N-cha	nnel), Source-drain diode	e characteristics				
V _{SD}	source-drain voltage	$I_{\rm S}$ = 380 mA; $V_{\rm GS}$ = 0 V; $T_{\rm j}$ = 25 °C	-	0.86	1.2	V
TR2 (P-chai	nnel), Source-drain diode	e characteristics				,
V _{SD}	source-drain voltage	I _S = -410 mA; V _{GS} = 0 V; T _i = 25 °C	-	-0.95	-1.2	V

30 V, complementary N/P-channel Trench MOSFET



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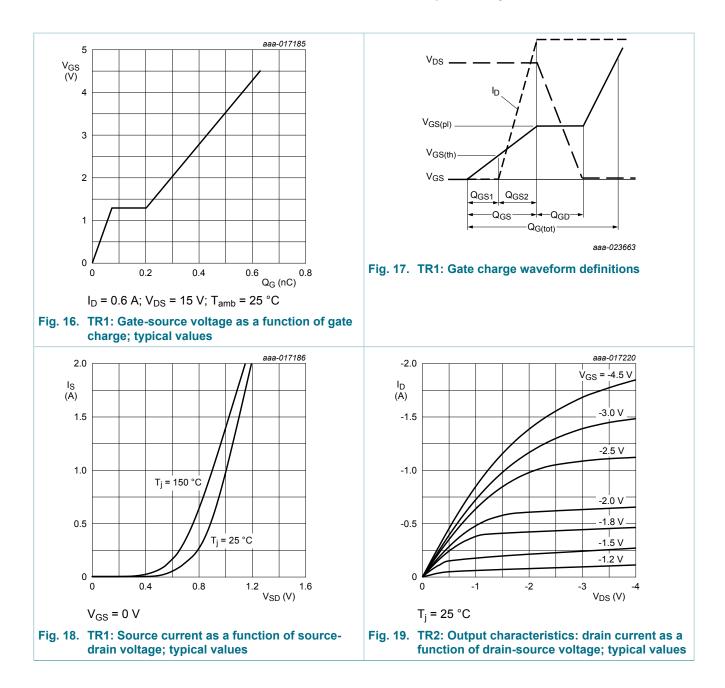
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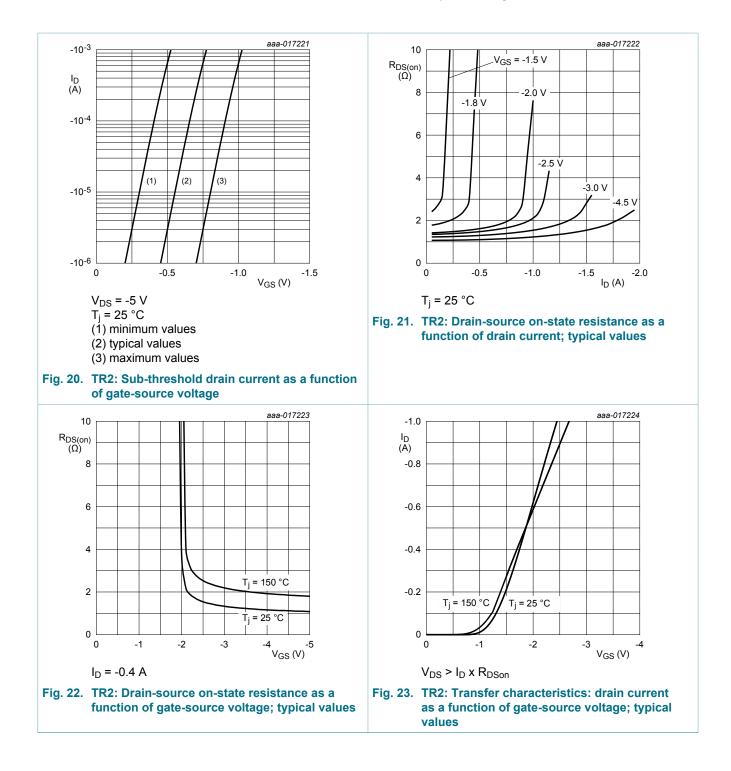
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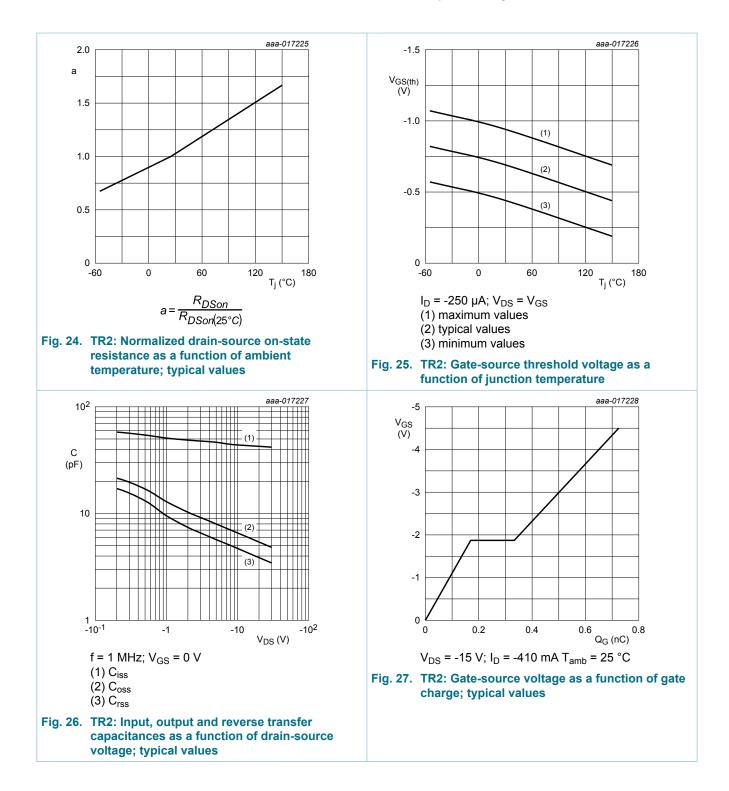
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30 V, complementary N/P-channel Trench MOSFET

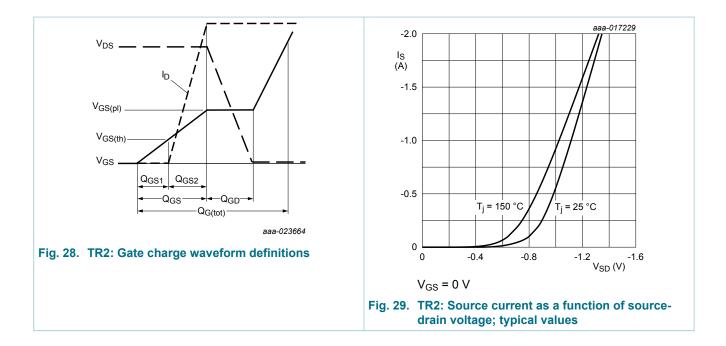


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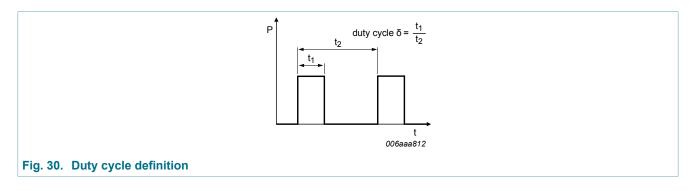
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11. Test information



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12. Package outline

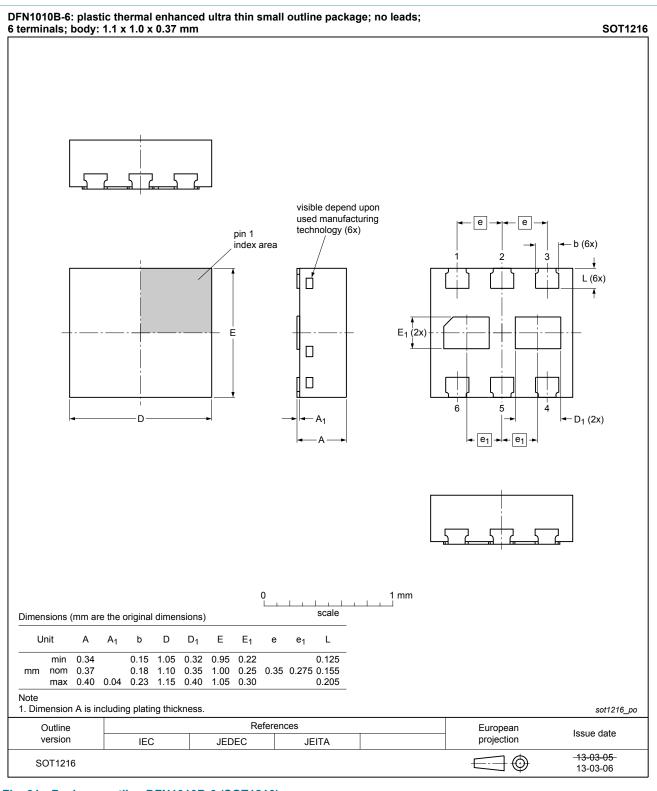
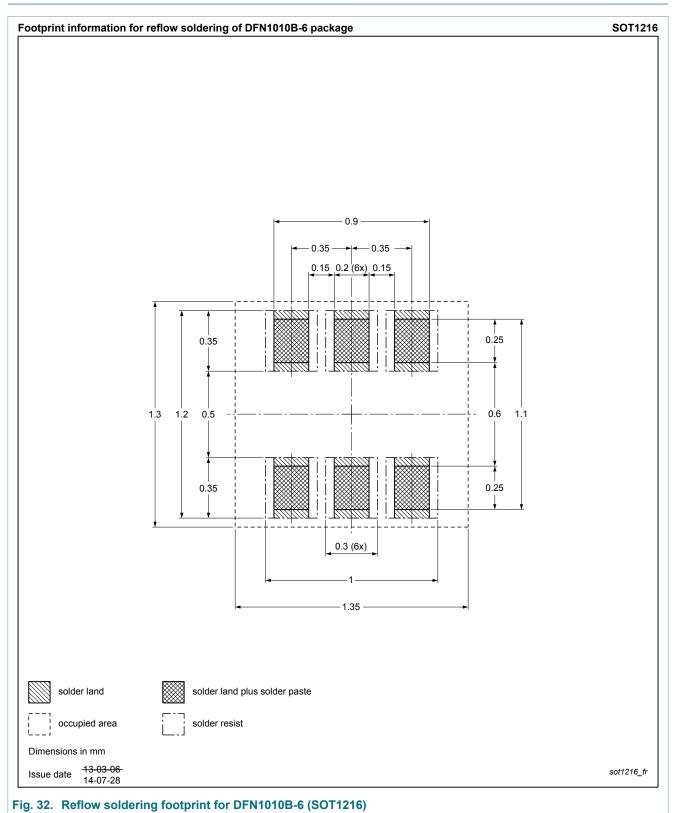


Fig. 31. Package outline DFN1010B-6 (SOT1216)

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30 V, complementary N/P-channel Trench MOSFET

13. Soldering



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30 V, complementary N/P-channel Trench MOSFET

14. Revision history

Table 8. Revision history					
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes	
PMCXB1000UE v.1	20160627	Product data sheet	-	-	

30 V, complementary N/P-channel Trench MOSFET

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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30 V, complementary N/P-channel Trench MOSFET

16. Contents

1. General description	1
2. Features and benefits	1
3. Applications	1
4. Quick reference data	1
5. Pinning information	2
6. Ordering information	2
7. Marking	2
8. Limiting values	3
9. Thermal characteristics	5
10. Characteristics	7
11. Test information	
12. Package outline	
13. Soldering	
14. Revision history	17
15. Legal information	18

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PMCXB1000UE